



Low Noise/Low Power/2-Wire Bus/256 Taps

X9258

Quad Digital Controlled Potentiometers (XDCP™)

FEATURES

- Four potentiometers in one package
- 256 resistor taps/pot–0.4% resolution
- 2-wire serial interface
- Wiper resistance, 40Ω typical @ $V_+ = 5V, V_- = -5V$
- Four nonvolatile data registers for each pot
- Nonvolatile storage of wiper position
- Standby current < 5μA max (total package)
- Power supplies
 - $V_{CC} = 2.7V$ to 5.5V
 - $V_+ = 2.7V$ to 5.5V
 - $V_- = -2.7V$ to -5.5V
- 100KΩ, 50KΩ total pot resistance
- High reliability
 - Endurance – 100,000 data changes per bit per register
 - Register data retention – 100 years
- 24-lead SOIC, 24-lead TSSOP, 24-lead CSP (Chip Scale Package)
- Dual supply version of X9258

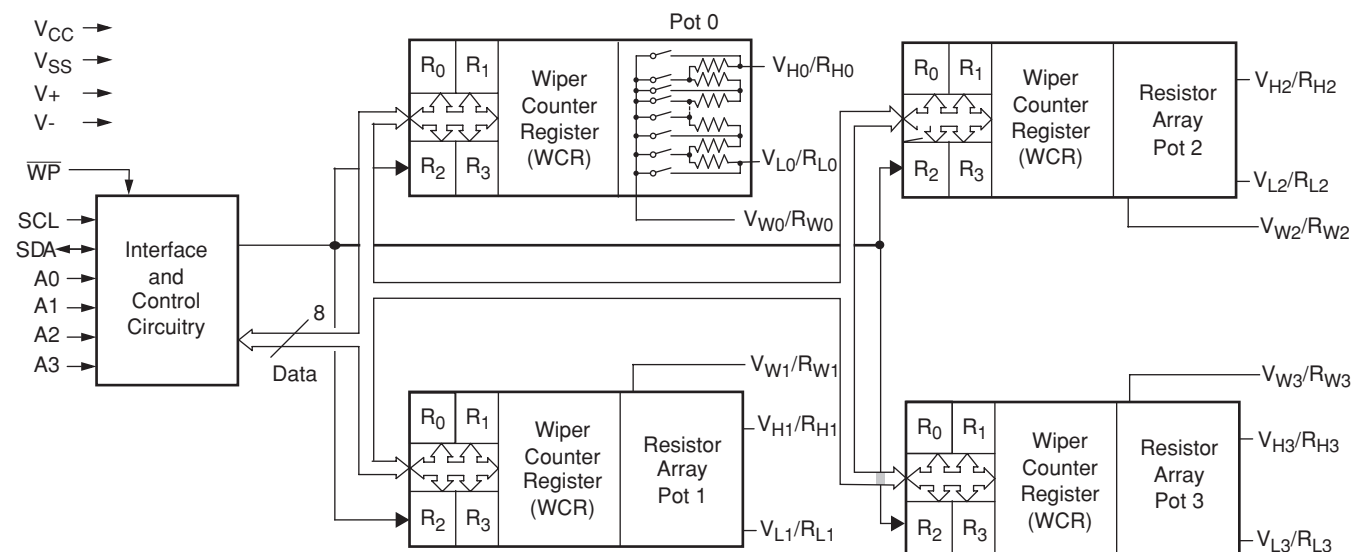
DESCRIPTION

The X9258 integrates 4 digitally controlled potentiometers (XDCP) on a monolithic CMOS integrated circuit.

The digitally controlled potentiometer is implemented using 255 resistive elements in a series array. Between each element are tap points connected to the wiper terminal through switches. The position of the wiper on the array is controlled by the user through the 2-wire bus interface. Each potentiometer has associated with it a volatile Wiper Counter Register (WCR) and 4 nonvolatile Data Registers (DR0:DR3) that can be directly written to and read by the user. The contents of the WCR controls the position of the wiper on the resistor array through the switches. Power up recalls the contents of DR0 to the WCR.

The XDCP can be used as a three-terminal potentiometer or as a two-terminal variable resistor in a wide variety of applications including control, parameter adjustments, and signal processing.

BLOCK DIAGRAM



X9258

PIN DESCRIPTIONS

Host Interface Pins

SERIAL CLOCK (SCL)

The SCL input is used to clock data into and out of the X9258.

SERIAL DATA (SDA)

SDA is a bidirectional pin used to transfer data into and out of the device. It is an open drain output and may be wire-ORed with any number of open drain or open collector outputs. An open drain output requires the use of a pull-up resistor. For selecting typical values, refer to the guidelines for calculating typical values on the bus pull-up resistors graph.

DEVICE ADDRESS (A_0 – A_3)

The Address inputs are used to set the least significant 4 bits of the 8-bit slave address. A match in the slave address serial data stream must be made with the address input in order to initiate communication with the X9258. A maximum of 16 devices may occupy the 2-wire serial bus.

Potentiometer Pins

V_H/R_H (V_{H0}/R_{H0} – V_{H3}/R_{H3}), V_L/R_L (V_{L0}/R_{L0} – V_{L3}/R_{L3})

The V_H/R_H and V_L/R_L inputs are equivalent to the terminal connections on either end of a mechanical potentiometer.

V_W/R_W (V_{W0}/R_{W0} – V_{W3}/R_{W3})

The wiper outputs are equivalent to the wiper output of a mechanical potentiometer.

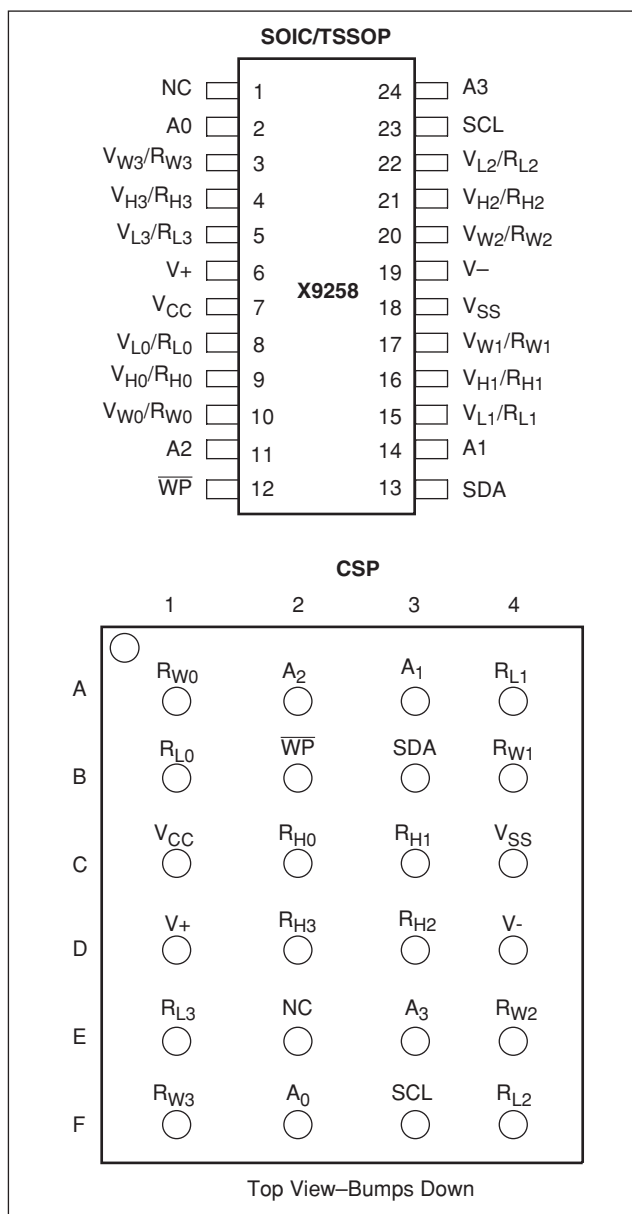
Hardware Write Protect Input (\overline{WP})

The \overline{WP} pin when low prevents nonvolatile writes to the Data Registers.

Analog Supplies V_+ , V_-

The Analog Supplies V_+ , V_- are the supply voltages for the DCP analog section.

PIN CONFIGURATION



PIN NAMES

Symbol	Description
SCL	Serial Clock
SDA	Serial Data
A0-A3	Device Address
$V_{H0}/R_{H0}-V_{H3}/R_{H3}$, $V_{L0}/R_{L0}-V_{L3}/R_{L3}$	Potentiometer Pins (terminal equivalent)
$V_{W0}/R_{W0}-V_{W3}/R_{W3}$	Potentiometers Pins (wiper equivalent)
\overline{WP}	Hardware Write Protection
V_+, V_-	Analog Supplies
V_{CC}	System Supply Voltage
V_{SS}	System Ground
NC	No Connection (Allowed)

PRINCIPLES OF OPERATION

The X9258 is a highly integrated microcircuit incorporating four resistor arrays and their associated registers and counters and the serial interface logic providing direct communication between the host and the DCP potentiometers.

Serial Interface—2-Wire

The X9258 supports a bidirectional bus oriented protocol. The protocol defines any device that sends data onto the bus as a transmitter and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master will always initiate data transfers and provide the clock for both transmit and receive operations. Therefore, the X9258 will be considered a slave device in all applications.

Clock and Data Conventions

Data states on the SDA line can change only during SCL LOW periods (t_{LOW}). SDA state changes during SCL HIGH are reserved for indicating start and stop conditions.

Start Condition

All commands to the X9258 are preceded by the start condition, which is a HIGH to LOW transition of SDA while SCL is HIGH (t_{HIGH}). The X9258 continuously monitors the SDA and SCL lines for the start condition and will not respond to any command until this condition is met.

Stop Condition

All communications must be terminated by a stop condition, which is a LOW to HIGH transition of SDA while SCL is HIGH.

Acknowledge

Acknowledge is a software convention used to provide a positive handshake between the master and slave devices on the bus to indicate the successful receipt of data. The transmitting device, either the master or the slave, will release the SDA bus after transmitting eight bits. The master generates a ninth clock cycle and during this period the receiver pulls the SDA line LOW to acknowledge that it successfully received the eight bits of data.

The X9258 will respond with an acknowledge after recognition of a start condition and its slave address and once again after successful receipt of the command byte. If the command is followed by a data byte the X9258 will respond with a final acknowledge.

Array Description

The X9258 is comprised of four resistor arrays. Each array contains 255 discrete resistive segments that are connected in series. The physical ends of each array are equivalent to the fixed terminals of a mechanical potentiometer (V_H/R_H and V_L/R_L inputs).

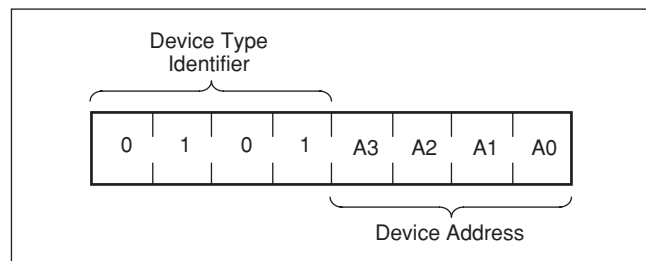
At both ends of each array and between each resistor segment is a CMOS switch connected to the wiper (V_W) output. Within each individual array only one switch may be turned on at a time. These switches are controlled by the Wiper Counter Register (WCR). The 8 bits of the WCR are decoded to select, and enable, one of 256 switches.

The WCR may be written directly, or it can be changed by transferring the contents of one of four associated data registers into the WCR. These data registers and the WCR can be read and written by the host system.

Device Addressing

Following a start condition the master must output the address of the slave it is accessing. The most significant four bits of the slave address are the device type identifier (refer to Figure 1 below). For the X9258 this is fixed as 0101[B].

Figure 1. Slave Address

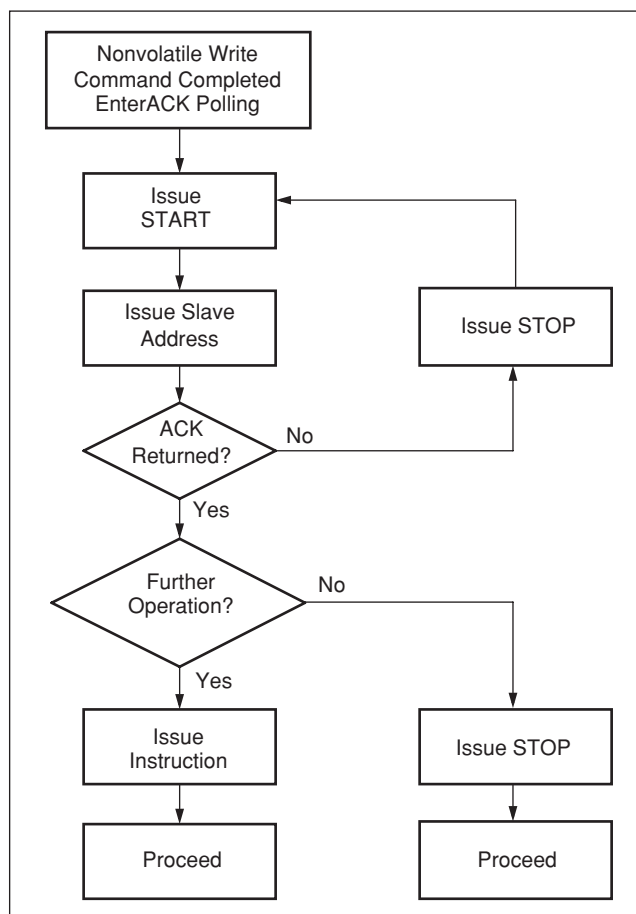


The next four bits of the slave address are the device address. The physical device address is defined by the state of the A0-A3 inputs. The X9258 compares the serial data stream with the address input state; a successful compare of all four address bits is required for the X9258 to respond with an acknowledge. The A₀–A₃ inputs can be actively driven by CMOS input signals or tied to V_{CC} or V_{SS}.

Acknowledge Polling

The disabling of the inputs, during the internal nonvolatile write operation, can be used to take advantage of the typical 5ms nonvolatile write cycle time. Once the stop condition is issued to indicate the end of the nonvolatile write command the X9258 initiates the internal write cycle. ACK polling can be initiated immediately. This involves issuing the start condition followed by the device slave address. If the X9258 is still busy with the write operation no ACK will be returned. If the X9258 has completed the write operation an ACK will be returned and the master can then proceed with the next operation.

ACK Polling Sequence



Instruction Structure

The next byte sent to the X9258 contains the instruction and register pointer information. The four most significant bits are the instruction. The next four bits point to one of the two pots and when applicable they point to one of four associated registers. The format is shown below in Figure 2.





Table 1. Instruction Set

Instruction	Instruction Set								Operation
	I ₃	I ₂	I ₁	I ₀	R ₁	R ₀	P ₁	P ₀	
Read Wiper Counter Register	1	0	0	1	0	0	1/0	1/0	Read the contents of the Wiper Counter Register pointed to by P ₁ –P ₀
Write Wiper Counter Register	1	0	1	0	0	0	1/0	1/0	Write new value to the Wiper Counter Register pointed to by P ₁ –P ₀
Read Data Register	1	0	1	1	1/0	1/0	1/0	1/0	Read the contents of the Data Register pointed to by P ₁ –P ₀ and R ₁ –R ₀
Write Data Register	1	1	0	0	1/0	1/0	1/0	1/0	Write new value to the Data Register pointed to by P ₁ –P ₀ and R ₁ –R ₀
XFR Data Register to Wiper Counter Register	1	1	0	1	1/0	1/0	1/0	1/0	Transfer the contents of the Data Register pointed to by P ₁ –P ₀ and R ₁ –R ₀ to its associated Wiper Counter Register
XFR Wiper Counter Register to Data Register	1	1	1	0	1/0	1/0	1/0	1/0	Transfer the contents of the Wiper Counter Register pointed to by P ₁ –P ₀ to the Data Register pointed to by R ₁ –R ₀
Global XFR Data Registers to Wiper Counter Registers	0	0	0	1	1/0	1/0	0	0	Transfer the contents of the Data Registers pointed to by R ₁ –R ₀ of all four pots to their respective Wiper Counter Registers
Global XFR Wiper Counter Registers to Data Register	1	0	0	0	1/0	1/0	0	0	Transfer the contents of both Wiper Counter Registers to their respective data Registers pointed to by R ₁ –R ₀ of all four pots
Increment/Decrement Wiper Counter Register	0	0	1	0	0	0	1/0	1/0	Enable Increment/decrement of the Control Latch pointed to by P ₁ –P ₀

Note: (1) 1/0 = data is one or zero

Figure 4. Three-Byte Instruction Sequence

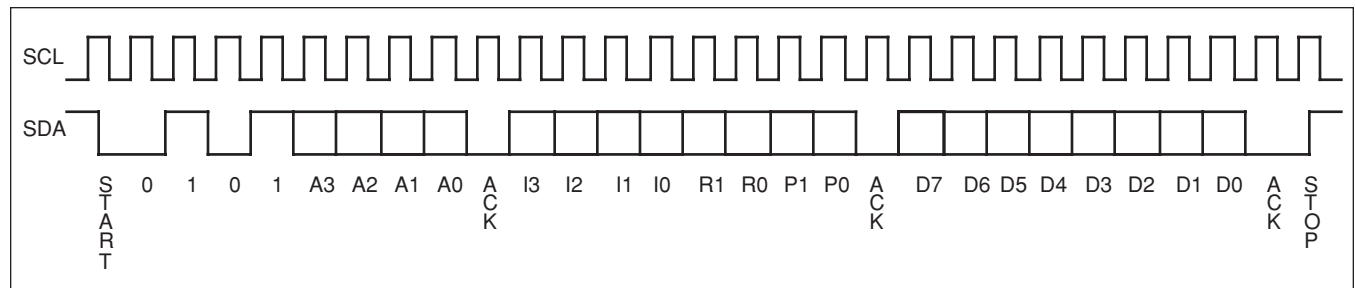


Figure 5. Increment/Decrement Instruction Sequence

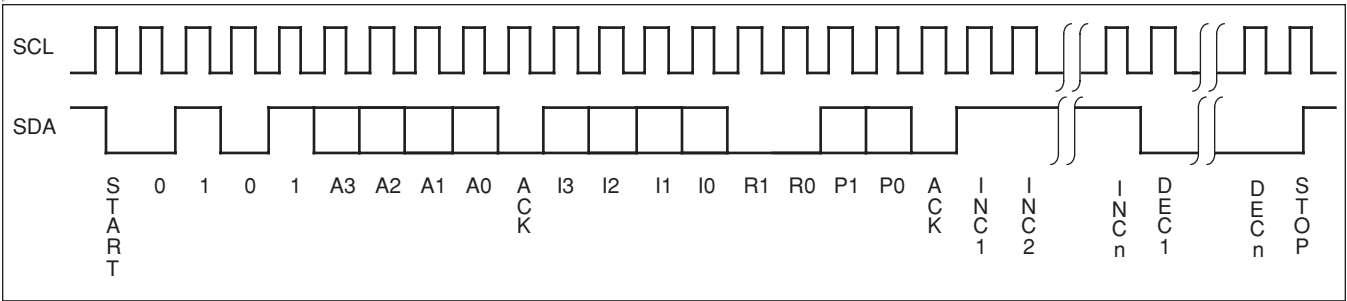


Figure 6. Increment/Decrement Timing Limits

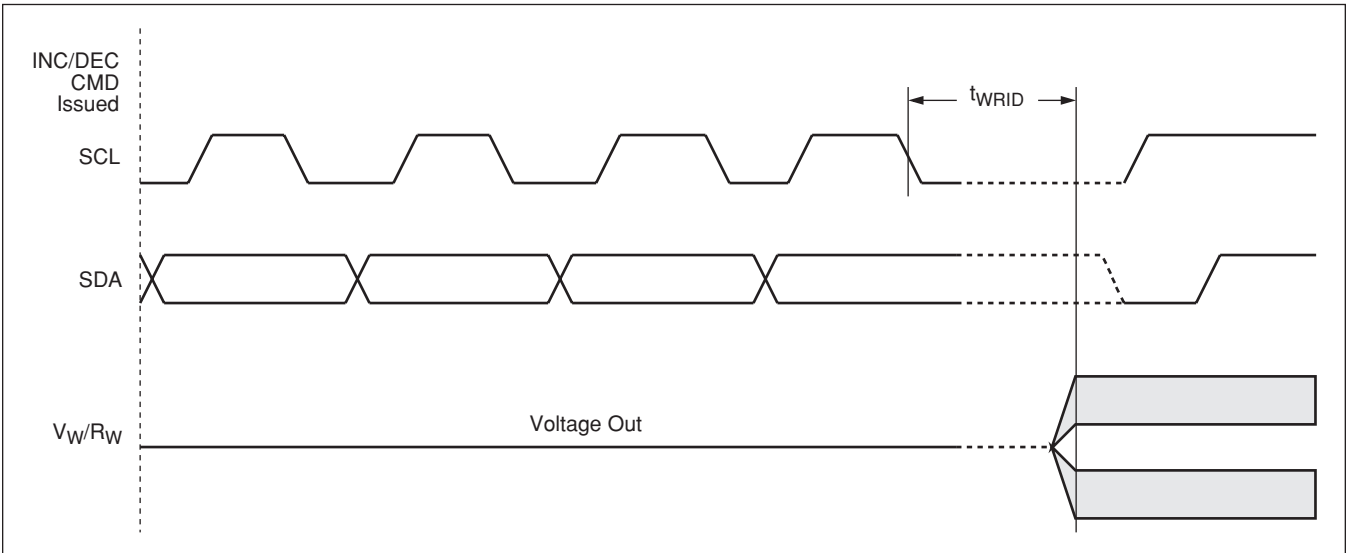


Figure 7. Acknowledge Response from Receiver

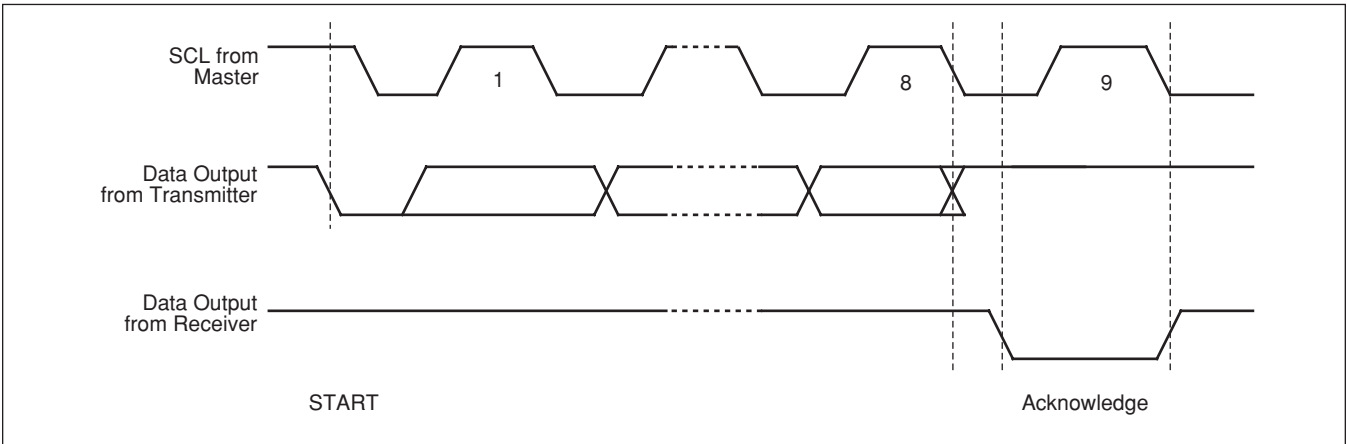
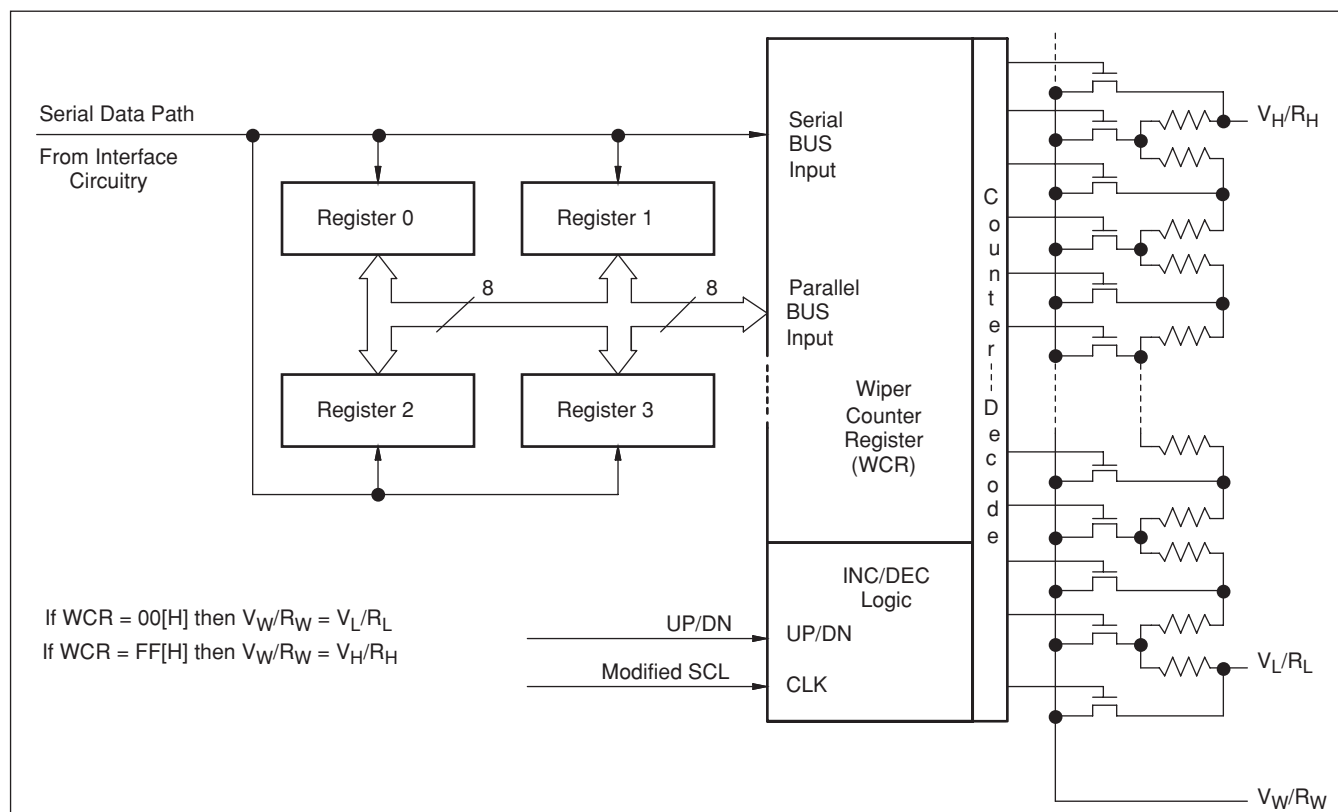


Figure 8. Detailed Potentiometer Block Diagram Detailed Operation



All DCP potentiometers share the serial interface and share a common architecture. Each potentiometer has a Wiper Counter Register and four Data Registers. A detailed discussion of the register organization and array operation follows.

Wiper Counter Register

The X9258 contains four Wiper Counter Registers, one for each DCP potentiometer. The Wiper Counter Register can be envisioned as a 8-bit parallel and serial load counter with its outputs decoded to select one of 256 switches along its resistor array. The contents of the WCR can be altered in four ways: it may be written directly by the host via the Write Wiper Counter Register instruction (serial load); it may be written indirectly by transferring the contents of one of four associated Data Registers via the XFR Data Register instruction (parallel load); it can be modified one step at a time by the Increment/Decrement instruction. Finally, it is loaded with the contents of its data register zero (R0) upon power-up.

The WCR is a volatile register; that is, its contents are lost when the X9258 is powered-down. Although the register is automatically loaded with the value in R0 upon power-up, it should be noted this may be different from the value present at power-down.

Data Registers

Each potentiometer has four nonvolatile Data Registers. These can be read or written directly by the host and data can be transferred between any of the four Data Registers and the WCR. It should be noted all operations changing data in one of these registers is a nonvolatile operation and will take a maximum of 10ms.

If the application does not require storage of multiple settings for the potentiometer, these registers can be used as regular memory locations that could possibly store system parameters or user preference data.

REGISTER DESCRIPTIONS

Data Registers, (8-Bit), Nonvolatile

WP7	WP6	WP5	WP4	WP3	WP2	WP1	WP0
NV	NV	NV	NV	NV	NV	NV	NV
(MSB)							(LSB)

Four 8-bit Data Registers for each DCP. (sixteen 8-bit registers in total).

- {D7~D0}: These bits are for general purpose not volatile data storage or for storage of up to four different wiper values. The contents of Data Register 0 are automatically moved to the wiper counter register on power-up.

Wiper Counter Register, (8-Bit), Volatile

WP7	WP6	WP5	WP4	WP3	WP2	WP1	WP0
V	V	V	V	V	V	V	V
(MSB)							(LSB)

One 8-bit Wiper Counter Register for each DCP. (Four 8-bit registers in total.)

- {D7~D0}: These bits specify the wiper position of the respective DCP. The Wiper Counter Register is loaded on power-up by the value in Data Register 0. The contents of the WCR can be loaded from any of the other Data Register or directly. The contents of the WCR can be saved in a DR.

Instruction Format

- Notes:** (1) "MACK"/"SACK": stands for the acknowledge sent by the master/slave.
 (2) "A3 ~ A0": stands for the device addresses sent by the master.
 (3) "X": indicates that it is a "0" for testing purpose but physically it is a "don't care" condition.
 (4) "I": stands for the increment operation, SDA held high during active SCL phase (high).
 (5) "D": stands for the decrement operation, SDA held low during active SCL phase (high).

Read Wiper Counter Register (WCR)

S T A R T	device type identifier				device addresses				S A C K	instruction opcode				WCR addresses				S A C K	wiper position (sent by slave on SDA)								M A C K	S T O P
	0	1	0	1	A 3	A 2	A 1	A 0		1	0	0	1	0	0	P 1	P 0		W P 7	W P 6	W P 5	W P 4	W P 3	W P 2	W P 1	W P 0		

Write Wiper Counter Register (WCR)

S T A R T	device type identifier				device addresses				S A C K	instruction opcode				WCR addresses				S A C K	Data Byte (sent by master on SDA)								S A C K	S T O P
	0	1	0	1	A 3	A 2	A 1	A 0		1	0	1	0	0	0	P 1	P 0		W P 7	W P 6	W P 5	W P 4	W P 3	W P 2	W P 1	W P 0		

Read Data Register (DR)

S T A R T	device type identifier				device addresses				S A C K	instruction opcode				DR and WCR addresses				S A C K	Data Byte (sent by slave on SDA)								M A C K	S T O P
	0	1	0	1	A 3	A 2	A 1	A 0		1	0	1	1	R 1	R 0	P 1	P 0		W P 7	W P 6	W P 5	W P 4	W P 3	W P 2	W P 1	W P 0		

Write Data Register (WR)

S T A R T	device type identifier				device addresses				S A C K	instruction opcode				DR and WCR addresses				S A C K	Data Byte (sent by master on SDA)								S A C K	S T O P	HIGH-VOLTAGE WRITE CYCLE
	0	1	0	1	A 3	A 2	A 1	A 0		1	1	0	0	R 1	R 0	P 1	P 0		W P 7	W P 6	W P 5	W P 4	W P 3	W P 2	W P 1	W P 0			

XFR Data Register (DR) to Wiper Counter Register (WCR)

S T A R T	device type identifier				device addresses				S A C K	instruction opcode				DR and WCR addresses				S A C K	S T O P
	0	1	0	1	A 3	A 2	A 1	A 0		1	1	0	1	R 1	R 0	P 1	P 0		

XFR Wiper Counter Register (WCR) to Data Register (DR)

S T A R T	device type identifier				device addresses				S A C K	instruction opcode				DR and WCR addresses				S A C K	S T O P	HIGH-VOLTAGE WRITE CYCLE
	0	1	0	1	A 3	A 2	A 1	A 0		1	1	1	0	R 1	R 0	P 1	P 0			

Increment/Decrement Wiper Counter Register (WCR)

S T A R T	device type identifier				device addresses				S A C K	instruction opcode				WCR addresses				S A C K	increment/decrement (sent by master on SDA)								S T O P
	0	1	0	1	A 3	A 2	A 1	A 0		0	0	1	0	0	0	P 1	P 0		I/ D	I/ D	I/ D	I/ D	

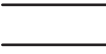




Global XFR Data Register (DR) to Wiper Counter Register (WCR)

S T A R T	device type identifier				device addresses				S A C K	instruction opcode				DR addresses				S A C K	S T O P
	0	1	0	1	A 3	A 2	A 1	A 0		0	0	0	1	R 1	R 0	0	0		

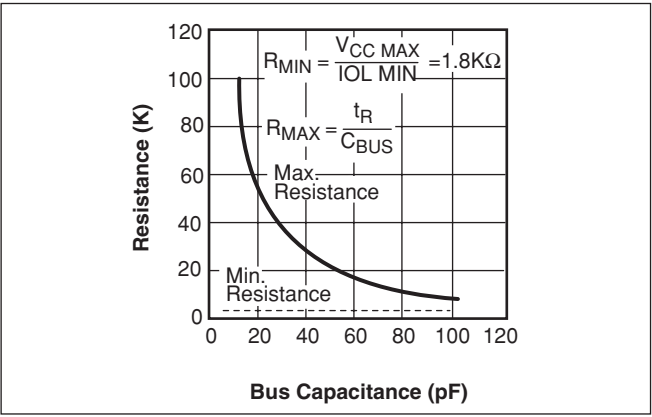
Global XFR Wiper Counter Register (WCR) to Data Register (DR)

S T A R T	device type identifier				device addresses				S A C K	instruction opcode				DR addresses				S A C K	S T O P	HIGH-VOLTAGE WRITE CYCLE
	0	1	0	1	A 3	A 2	A 1	A 0		1	0	0	0	R 1	R 0	0	0			

SYMBOL TABLE

WAVEFORM	INPUTS	OUTPUTS
	Must be steady	Will be steady
	May change from Low to High	Will change from Low to High
	May change from High to Low	Will change from High to Low
	Don't Care: Changes Allowed	Changing: State Not Known
	N/A	Center Line is High Impedance

Guidelines for Calculating Typical Values of Bus Pull-Up Resistors



X9258

ABSOLUTE MAXIMUM RATINGS

Temperature under bias-65°C to +135°C
 Storage temperature-65°C to +150°C
 Voltage on SDA, SCL or any address input
 with respect to V_{SS}-1V to +7V
 Voltage on V_+ (referenced to V_{SS})..... 10V
 Voltage on V_- (referenced to V_{SS}).....-10V
 (V_+) - (V_-)..... 12V
 Any V_H/R_H V_+
 Any V_L/R_L V_-
 Lead temperature (soldering, 10 seconds)..... 300°C
 I_W (10 seconds)..... ± 15 mA

COMMENT

Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only; functional operation of the device (at these or any other conditions above those listed in the operational sections of this specification) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Temperature	Min.	Max.
Commercial	0°C	+70°C
Industrial	-40°C	+85°C

Device	Supply Voltage (V_{CC}) Limits
X9258	5V $\pm 10\%$
X9258-2.7	2.7V to 5.5V

ANALOG CHARACTERISTICS

(Over recommended operating conditions unless otherwise stated.)

Symbol	Parameter		Limits				Test Conditions
			Min.	Typ.	Max.	Unit	
	End to end resistance tolerance				± 20	%	
	Power rating				50	mW	25°C, each pot
I_W	Wiper current				± 7.5	mA	Wiper current = ± 1 mA
R_W	Wiper resistance			150	250	Ω	$I_W = \pm 1$ mA @ $V_+ = 3$ V, $V_- = -3$ V
R_W	Wiper resistance			40	100	Ω	$I_W = \pm 1$ mA @ $V_+ = 5$ V, $V_- = -5$ V
V_+	Voltage on V_+ Pin	X9258	+4.5		+5.5	V	
		X9258-2.7	+2.7		+5.5		
V_-	Voltage on V_- Pin	X9258	-5.5		-4.5	V	
		X9258-2.7	-5.5		-2.7		
V_{TERM}	Voltage on any V_H/R_H or V_L/R_L pin		V_-		V_+	V	
	Noise			-120		dBV	Ref: 1kHz
	Resolution ⁽⁴⁾			0.6		%	
	Absolute linearity ⁽¹⁾				± 1	MI ⁽³⁾	$V_{w(n)(actual)} - V_{w(n)(expected)}$
	Relative linearity ⁽²⁾				± 0.6	MI ⁽³⁾	$V_{w(n+1)} - [V_{w(n)} + MI]$
	Temperature coefficient of R_{TOTAL}			± 300		ppm/°C	
	Ratiometric Temperature Coefficient				± 20	ppm/°C	
$C_H/C_L/C_W$	Potentiometer Capacitance			10/10/25		pF	See Circuit #3

D.C. OPERATING CHARACTERISTICS (Over the recommended operating conditions unless otherwise specified.)

Symbol	Parameter	Limits				Test Conditions
		Min.	Typ.	Max.	Unit	
I_{CC1}	V_{CC} supply current (Non-volatile Write)		1		mA	$f_{SCL} = 400\text{kHz}$, SDA = Open, Other Inputs = V_{SS}
I_{CC2}	V_{CC} supply current (move wiper, write, read)			100	μA	$f_{SCL} = 400\text{kHz}$, SDA = Open, Other Inputs = V_{SS}
I_{SB}	V_{CC} current (standby)			5	μA	SCL = SDA = V_{CC} , Addr. = V_{SS}
I_{LI}	Input leakage current			10	μA	$V_{IN} = V_{SS}$ to V_{CC}
I_{LO}	Output leakage current			10	μA	$V_{OUT} = V_{SS}$ to V_{CC}
V_{IH}	Input HIGH voltage	$V_{CC} \times 0.7$		$V_{CC} + 0.1$	V	
V_{IL}	Input LOW voltage	-0.5		$V_{CC} \times 0.3$	V	
V_{OL}	Output LOW voltage			0.4	V	$I_{OL} = 3\text{mA}$

Notes: (1) Absolute linearity is utilized to determine actual wiper voltage versus expected voltage as determined by wiper position when used as a potentiometer.
(2) Relative linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.
(3) $MI = RTOT/255$ or $(V_H/R_H - V_L/R_L)/255$, single pot
(4) Max. = all four arrays cascaded together, Typical = individual array resolutions.

ENDURANCE AND DATA RETENTION

Parameter	Min.	Unit
Minimum endurance	100,000	Data changes per bit per register
Data retention	100	years

CAPACITANCE

Symbol	Test	Max.	Unit	Test Conditions
$C_{I/O}^{(5)}$	Input/output capacitance (SDA)	8	pF	$V_{I/O} = 0\text{V}$
$C_{IN}^{(5)}$	Input capacitance (A0, A1, A2, A3, and SCL)	6	pF	$V_{IN} = 0\text{V}$

POWER-UP TIMING

Symbol	Parameter	Min.	Max.	Unit
$t_{PUR}^{(6)}$	Power-up to initiation of read operation		1	ms
$t_{PUW}^{(6)}$	Power-up to initiation of write operation		5	ms
$t_R V_{CC}^{(7)}$	V_{CC} Power up ramp	0.2	50	V/msec

POWER UP AND DOWN REQUIREMENT

There are no restrictions on the sequencing of the bias supplies V_{CC} , V_+ , and V_- provided that all three supplies reach their final values within 1msec of each other. At all times, the voltages on the potentiometer pins must be less than V_+ and more than V_- . The recall of the wiper position from nonvolatile memory is not in effect until all supplies reach their final value. The V_{CC} ramp rate spec is always in effect.

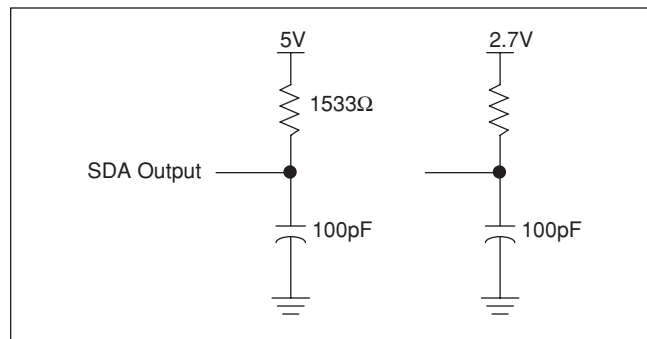
Notes: (5) This parameter is periodically sampled and not 100% tested.
(6) t_{PUR} and t_{PUW} are the delays required from the time the third (last) power supply (V_{CC} , V_+ or V_-) is stable until the specific instruction can be issued. These parameters are periodically sampled and not 100% tested.
(7) Sample tested only.

X9258

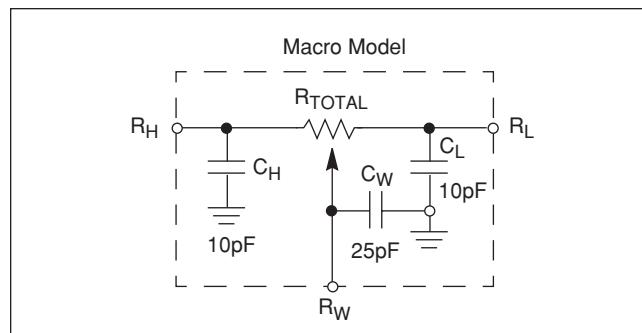
A.C. TEST CONDITIONS

Input pulse levels	$V_{CC} \times 0.1$ to $V_{CC} \times 0.9$
Input rise and fall times	10ns
Input and output timing level	$V_{CC} \times 0.5$

EQUIVALENT A.C. LOAD CIRCUIT



Test Circuit #3 SPICE Macro Model



AC TIMING (Over recommended operating condition)

Symbol	Parameter	Min.	Max.	Unit
f_{SCL}	Clock frequency		400	kHz
t_{CYC}	Clock cycle time	2500		ns
t_{HIGH}	Clock high time	600		ns
t_{LOW}	Clock low time	1300		ns
$t_{SU:STA}$	Start setup time	600		ns
$t_{HD:STA}$	Start hold time	600		ns
$t_{SU:STO}$	Stop setup time	600		ns
$t_{SU:DAT}$	SDA data input setup time	100		ns
$t_{HD:DAT}$	SDA data input hold time	30		ns
t_R	SCL and SDA rise time		300	ns
t_F	SCL and SDA fall time		300	ns
t_{AA}	SCL low to SDA data output valid time		900	ns
t_{DH}	SDA data output hold time	50		ns
T_I	Noise suppression time constant at SCL and SDA inputs	50		ns
t_{BUF}	Bus free time (prior to any transmission)	1300		ns
$t_{SU:WPA}$	\overline{WP} , A0, A1, A2 and A3 setup time	0		ns
$t_{HD:WPA}$	\overline{WP} , A0, A1, A2 and A3 hold time	0		ns

HIGH-VOLTAGE WRITE CYCLE TIMING

Symbol	Parameter	Typ.	Max.	Unit
t_{WR}	High-voltage write cycle time (store instructions)	5	10	ms

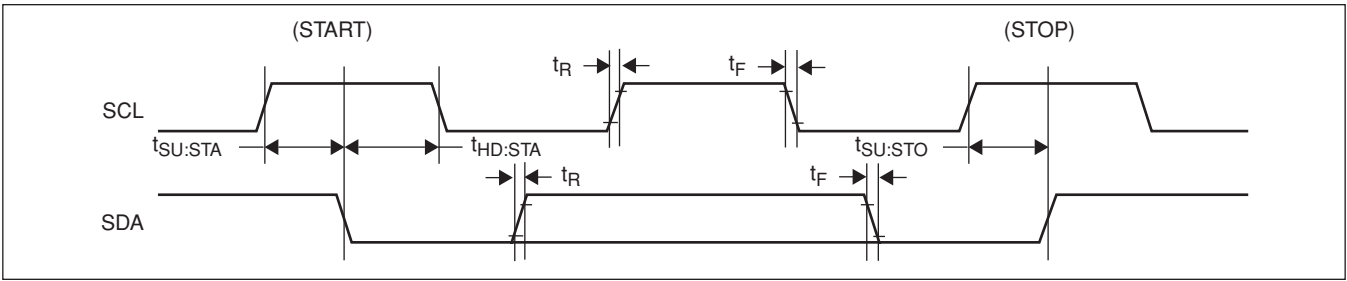
DCP TIMING

Symbol	Parameter	Min.	Max.	Unit
t_{WRPO}	Wiper response time after the third (last) power supply is stable		10	μs
t_{WRL}	Wiper response time after instruction issued (all load instructions)		10	μs
t_{WRID}	Wiper response time from an active SCL/SCK edge (increment/decrement instruction)		10	μs

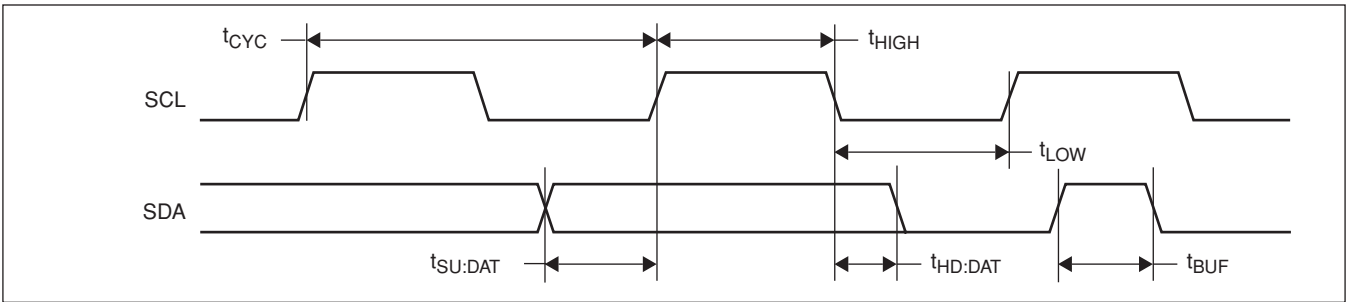
Note: (8) A device must internally provide a hold time of at least 300ns for the SDA signal in order to bridge the undefined region of the falling edge of SCL.

TIMING DIAGRAMS 2-WIRE INTERFACE

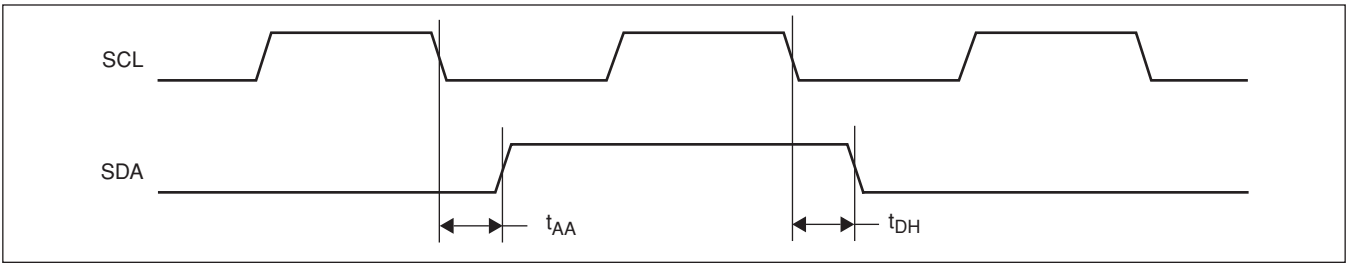
START and STOP Timing



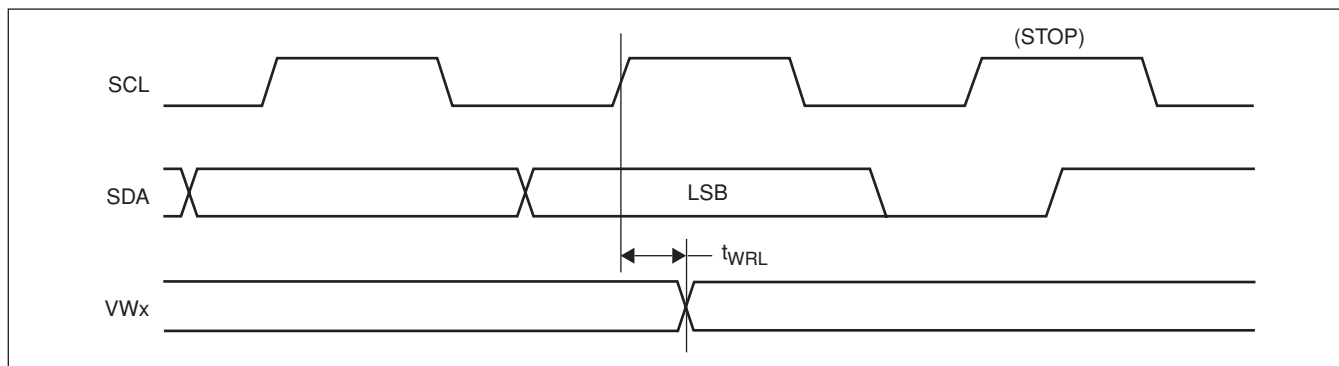
Input Timing



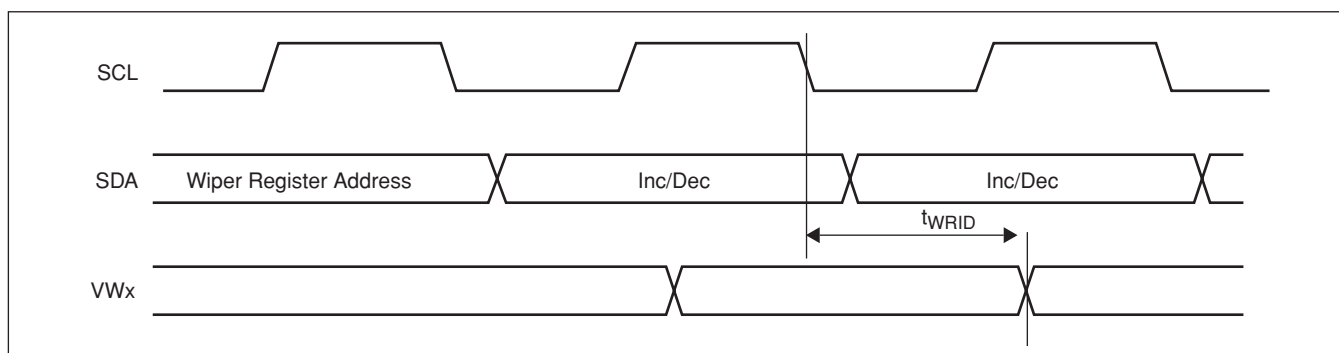
Output Timing



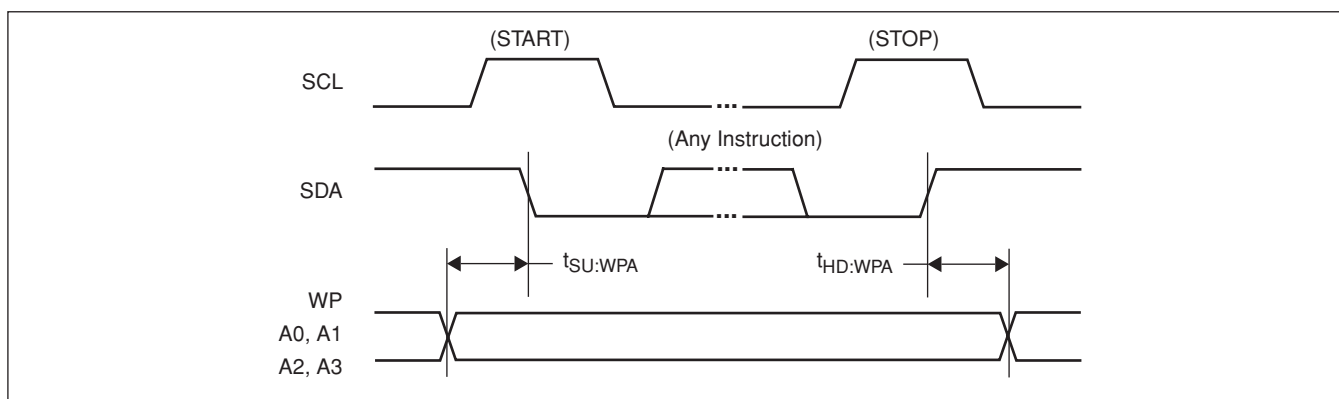
DCP Timing (for All Load Instructions)



DCP Timing (for Increment/Decrement Instruction)

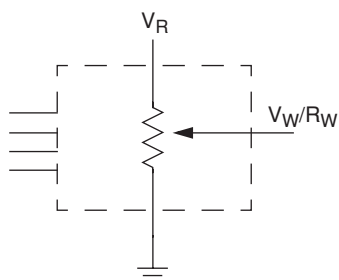


Write Protect and Device Address Pins Timing

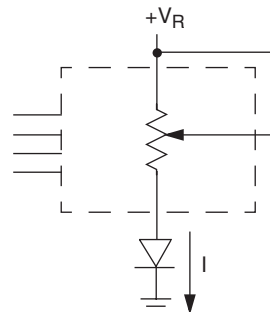


APPLICATIONS INFORMATION

Basic Configurations of Electronic Potentiometers



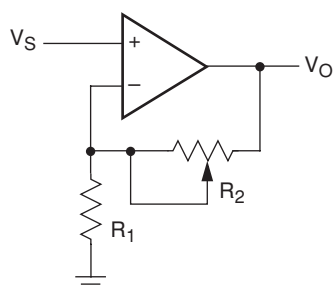
Three terminal Potentiometer;
Variable voltage divider



Two terminal Variable Resistor;
Variable current

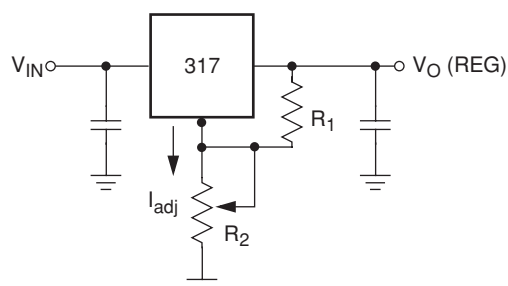
Application Circuits

Noninverting Amplifier



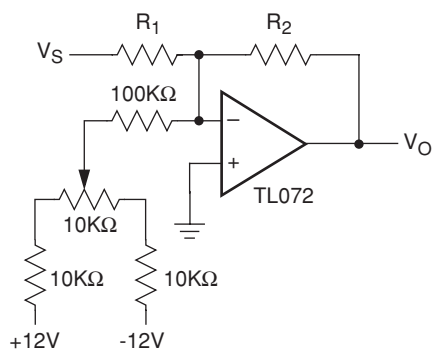
$$V_O = (1 + R_2/R_1)V_S$$

Voltage Regulator

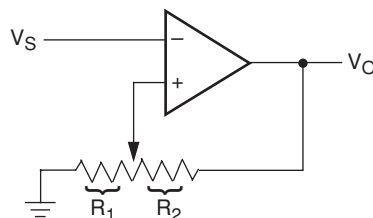


$$V_O (\text{REG}) = 1.25V (1 + R_2/R_1) + I_{\text{adj}} R_2$$

Offset Voltage Adjustment



Comparator with Hysteresis

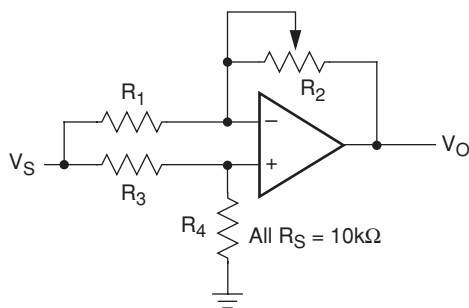


$$V_{UL} = \{R_1/(R_1 + R_2)\} V_O(\text{max})$$

$$V_{LL} = \{R_1/(R_1 + R_2)\} V_O(\text{min})$$

Application Circuits (continued)

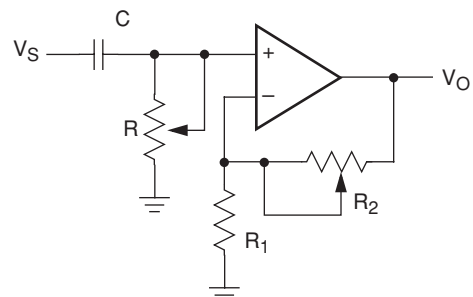
Attenuator



$$V_O = G V_S$$

$$-1/2 \leq G \leq +1/2$$

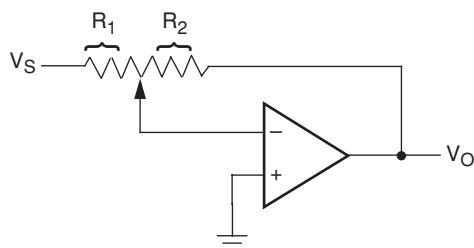
Filter



$$G_O = 1 + R_2/R_1$$

$$f_c = 1/(2\pi RC)$$

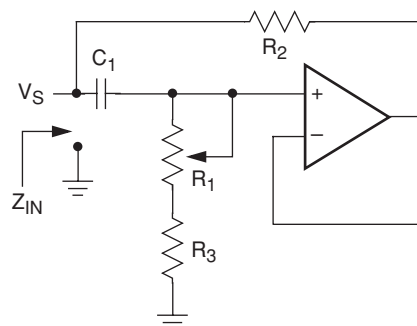
Inverting Amplifier



$$V_O = G V_S$$

$$G = -R_2/R_1$$

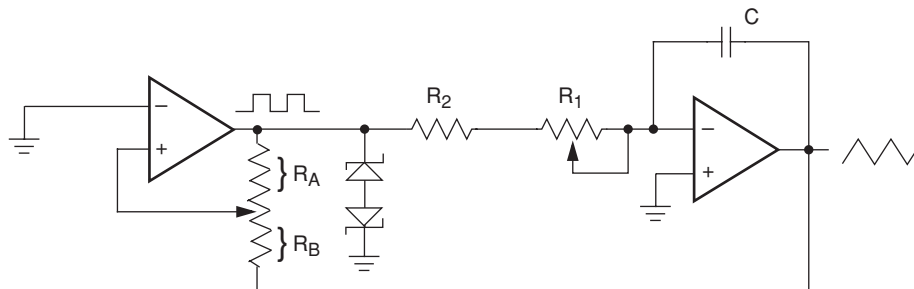
Equivalent L-R Circuit



$$Z_{IN} = R_2 + s R_2 (R_1 + R_3) C_1 = R_2 + s L_{eq}$$

$$(R_1 + R_3) \gg R_2$$

Function Generator

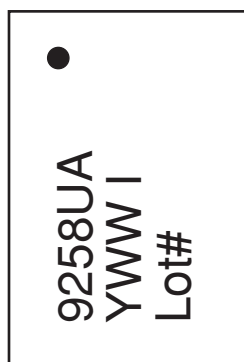


$$\text{frequency} \propto R_1, R_2, C$$

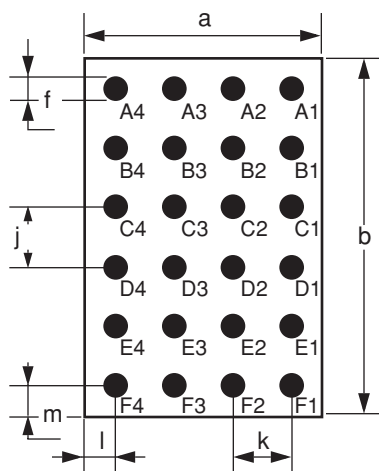
$$\text{amplitude} \propto R_A, R_B$$

PACKAGING INFORMATION

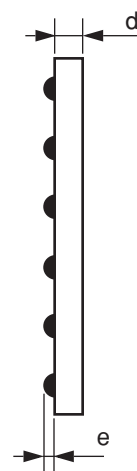
24-Bump Chip Scale Package (CSP B24) Package Outline Drawing



Top View (Sample Marking)



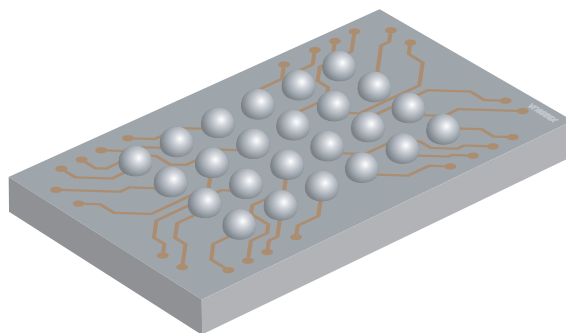
Bottom View (Bumped Side)



Side View



Side View



Package Dimensions

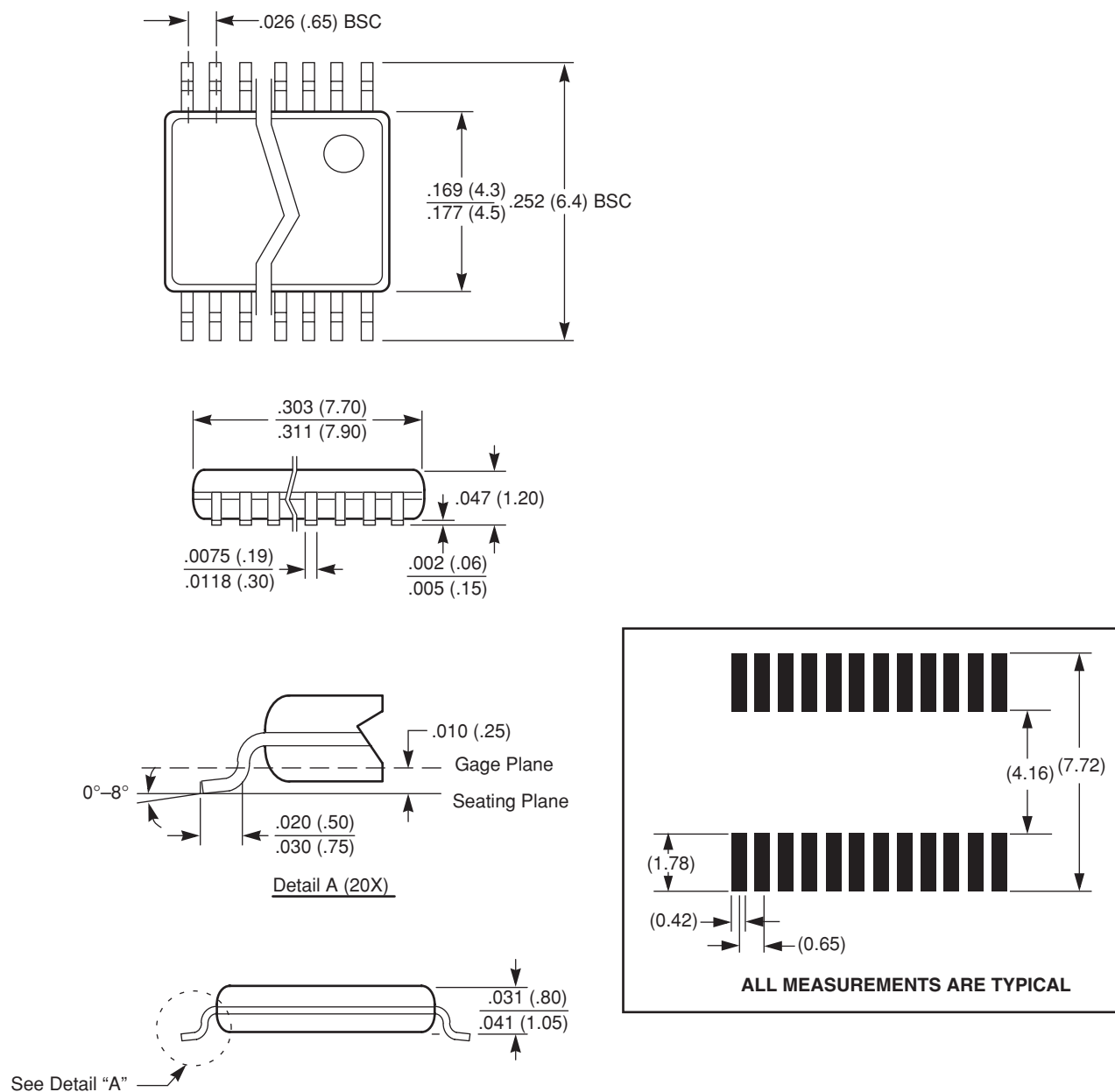
	Symbol	Millimeters		
		Min	Nominal	Max
Package Width	a	2.771	2.801	2.831
Package Length	b	4.549	4.579	4.609
Package Height	c	0.644	0.677	0.710
Body Thickness	d	0.444	0.457	0.470
Ball Height	e	0.200	0.220	0.240
Ball Diameter	f	0.300	0.320	0.340
Ball Pitch – Width	j		0.5	
Ball Pitch – Length	k		0.5	
Ball to Edge Spacing – Width	l	0.626	0.651	0.676
Ball to Edge Spacing – Length	m	1.015	1.040	1.065

Ball Matrix:

	4	3	2	1
A	R _{L1}	A1	A2	R _{W0}
B	R _{W1}	SDA	\overline{WP}	R _{L0}
C	VSS	R _{H1}	R _{H0}	VCC
D	V-	R _{H2}	R _{H3}	V+
E	R _{W2}	A3	NC	R _{L3}
F	R _{L2}	SCL	A0	R _{W3}

PACKAGING INFORMATION

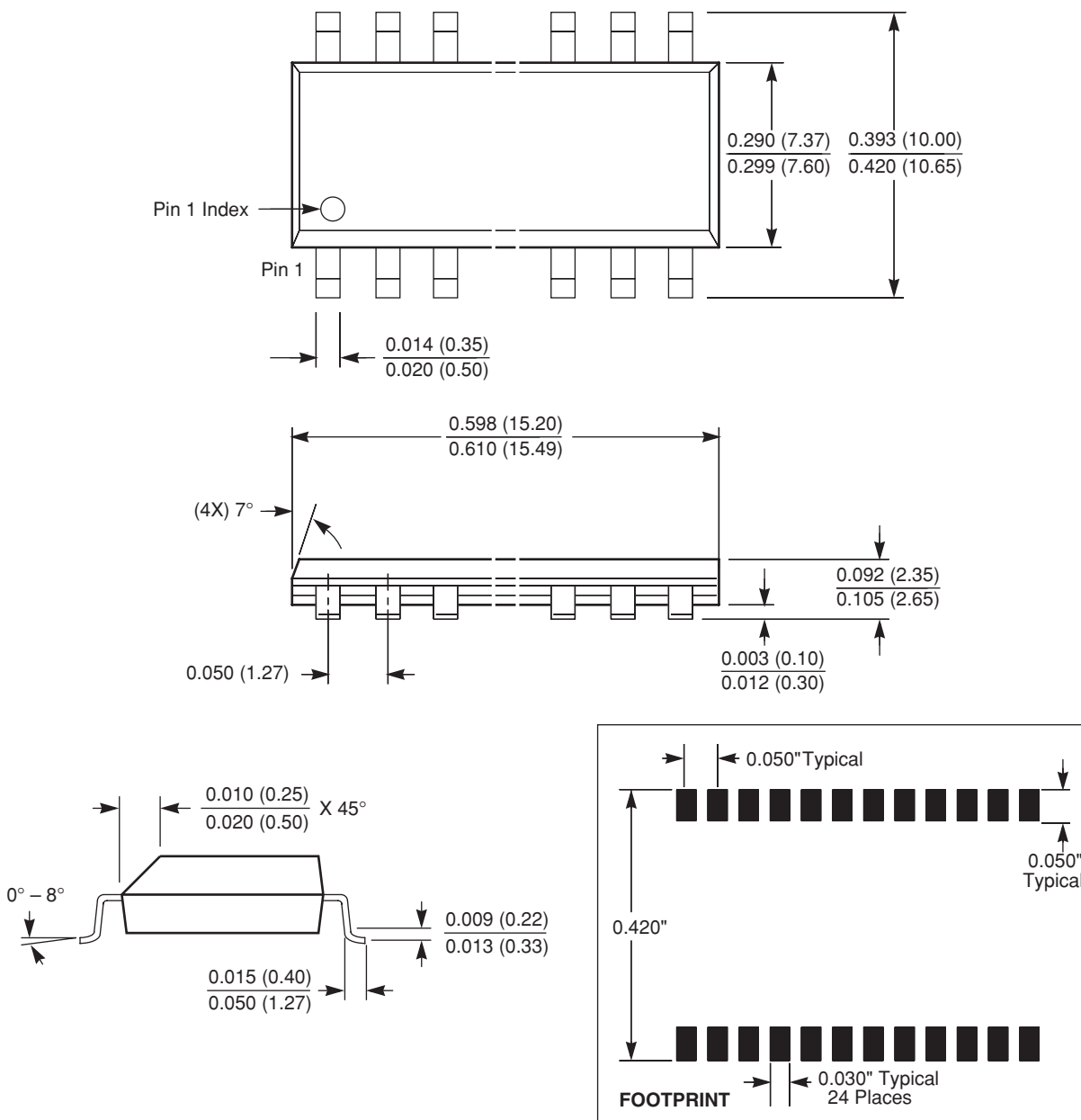
24-Lead Plastic, TSSOP, Package Code V24



NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

PACKAGING INFORMATION

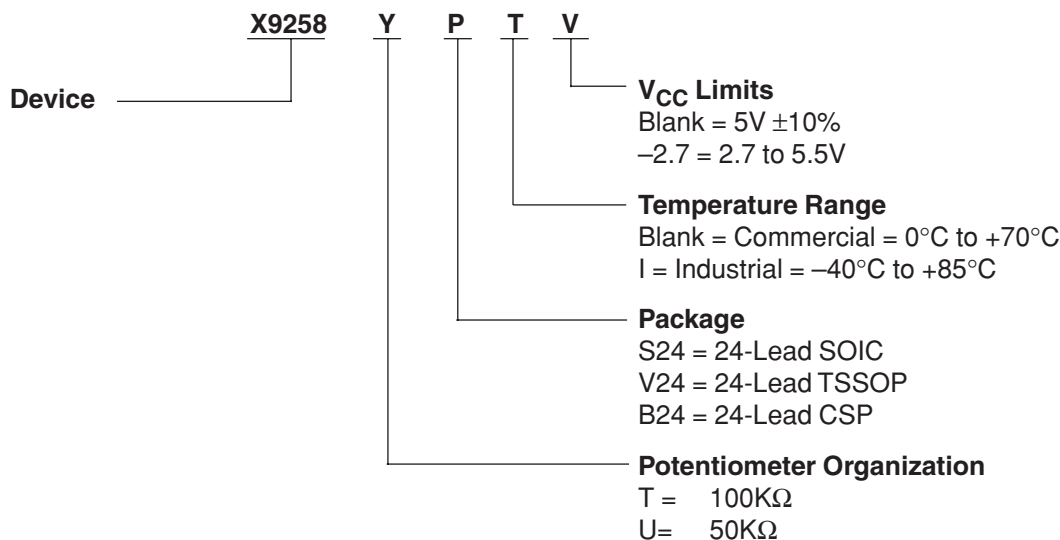
24-Lead Plastic Small Outline Gull Wing Package Type S



NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

X9258

Ordering Information



S & V Package Marking

Line #1	(Blank)	
Line #2	(Part Number)	
Line #3	(Date Code) (*)	
Line #4	(Blank)	

= F 2.7V 0 to 70°C
G 2.7V -40 to +85°C
I 5V -40 to +85°C

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.